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(12) **United States Design Patent** (10) **Patent No.:** **US D843,334 S**
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(54) **FLEXIBLE PRINTED CIRCUITS**
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(52) **U.S. Cl.**
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361/763, 751; 174/250, 253, 255, 68.1,
174/256, 257; 363/144, 147; 700/22;
318/567, 568.1
CPC H05K 3/284; H05K 3/30; H05K 3/301;
H05K 3/303; H05K 1/18; H05K 1/181;
H05K 1/182; H05K 1/183; H05K 1/185;
H05K 1/00; H05K 1/02; H05K 1/0213;
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2201/057; H05K 2201/09018; H01L
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See application file for complete search history.

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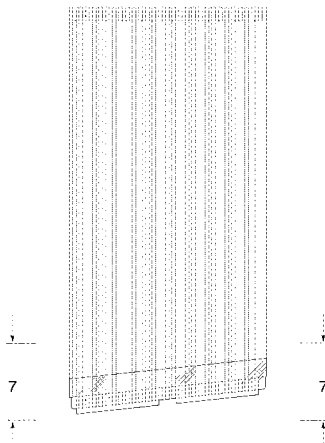
(57) **CLAIM**

The ornamental design for a flexible printed circuit, as shown and described.

DESCRIPTION

FIG. 1 is a front view of a flexible printed circuit showing our new design;
FIG. 2 is a rear view thereof;
FIG. 3 is a top view thereof;
FIG. 4 is a bottom view thereof;
FIG. 5 is a right view thereof;
FIG. 6 is a left view thereof; and,
FIG. 7 is an enlarged portion view delimited by the lines labelled 7 in FIG. 1.
The even broken lines in the drawings depict unclaimed subject matter only and form no part of the claimed design. The dashed-dot lines in the drawings depict a boundary between the claimed design and the unclaimed subject matter and form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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Fig. 1

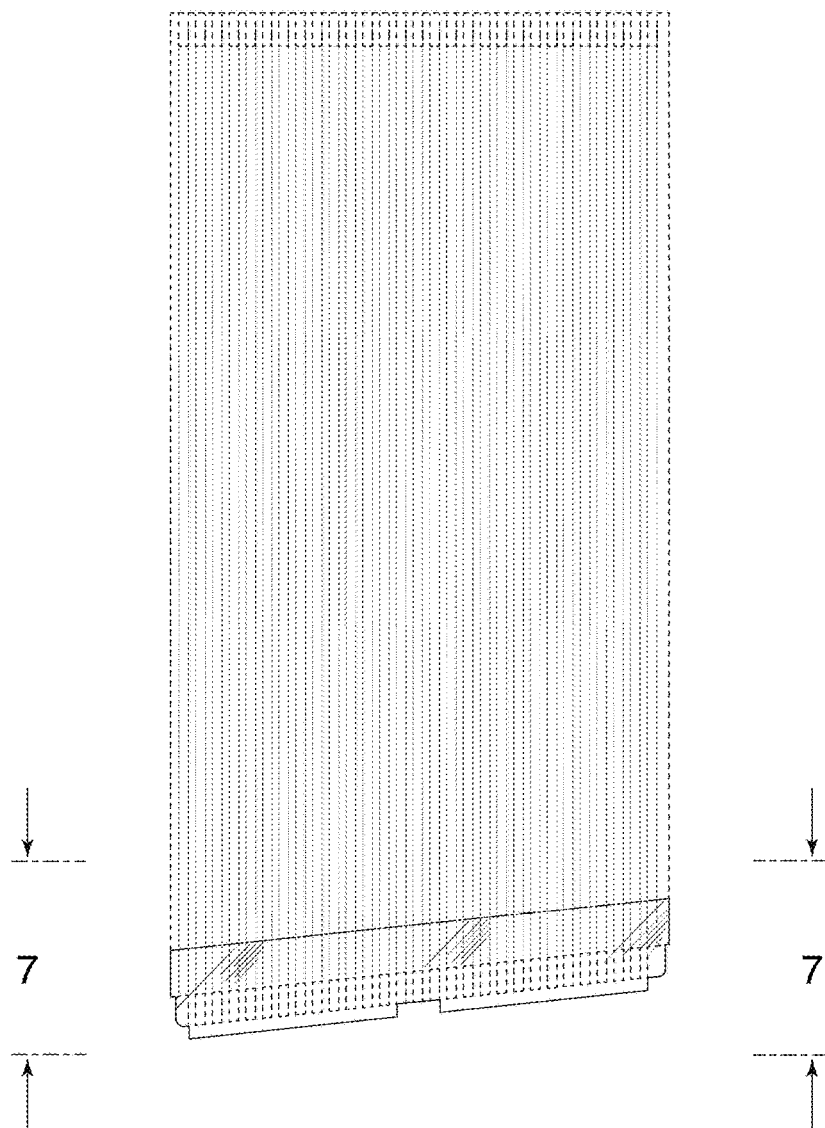


Fig.2

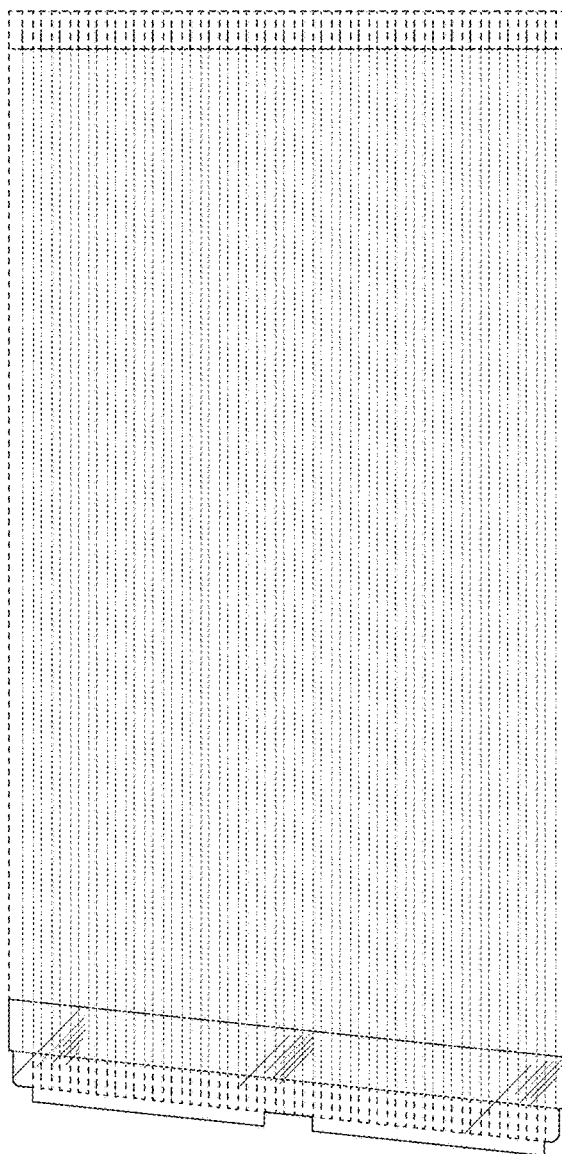


Fig.3

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Fig. 4

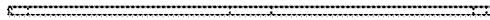


Fig. 5



Fig.6

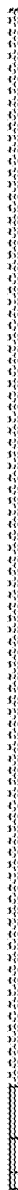


Fig.7

